

PHASE CONTROL THYRISTORS

Stud Version

80A

Features

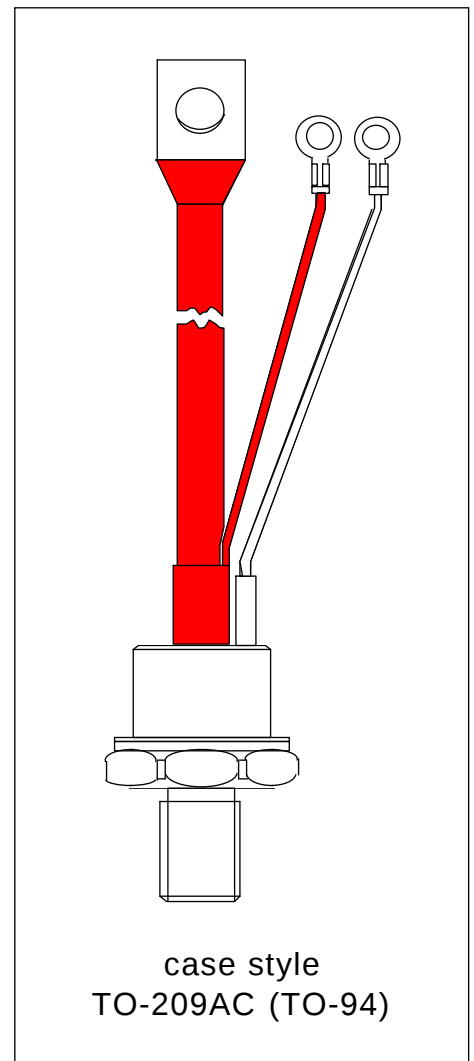
- All diffused design
- Glass-metal seal up to 1200V
- International standard case TO-209AC (TO-94)
- Threaded studs UNF 1/2 - 20UNF2A or ISO M12x1.75

Typical Applications

- DC motor controls
- Controlled DC power supplies
- AC controllers

Major Ratings and Characteristics

Parameters	80RIA	Unit
$I_{T(AV)}$	80	A
@ T_C	85	°C
$I_{T(RMS)}$	125	A
I_{TSM} @ 50Hz	1900	A
@ 60Hz	1990	A
I^2t @ 50Hz	18	KA ² s
@ 60Hz	16	KA ² s
V_{DRM}/V_{RRM}	400 to 1200	V
t_q typical	110	μs
T_J	- 40 to 125	°C



ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , max. repetitive peak and off-state voltage V	V_{RSM} , maximum non-repetitive peak voltage V	I_{DRM}/I_{RRM} max. @ $T_J = 125^\circ\text{C}$ mA
80RIA	40	400	500	15
	80	800	900	
	120	1200	1300	

On-state Conduction

Parameter	80RIA	Units	Conditions
$I_{T(AV)}$ Max. average on-state current @ Case temperature	80	A	180° conduction, half sine wave
	85	°C	
$I_{T(RMS)}$ Max. RMS on-state current	125	A	DC @ 75°C case temperature
I_{TSM} Max. peak, one-cycle non-repetitive surge current	1900	A	t = 10ms No voltage
	1990		t = 8.3ms reapplied
	1600		t = 10ms 100% V_{RRM}
	1675		t = 8.3ms reapplied
I^2t Maximum I^2t for fusing	18	KA^2s	t = 10ms No voltage
	16		t = 8.3ms reapplied
	12.7		t = 10ms 100% V_{RRM}
	11.7		t = 8.3ms reapplied
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	180.5	$KA^2\sqrt{s}$	t = 0.1 to 10ms, no voltage reapplied
$V_{T(TO)1}$ Low level value of threshold voltage	0.99	V	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, $T_J = T_J \text{ max.}$
$V_{T(TO)2}$ High level value of threshold voltage	1.13		$(I > \pi \times I_{T(AV)})$, $T_J = T_J \text{ max.}$
r_{t1} Low level value of on-state slope resistance	2.29	$m\Omega$	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, $T_J = T_J \text{ max.}$
r_{t2} High level value of on-state slope resistance	1.84		$(I > \pi \times I_{T(AV)})$, $T_J = T_J \text{ max.}$
V_{TM} Max. on-state voltage	1.60	V	$I_{pk} = 250A$, $T_J = 25^\circ\text{C}$ $t_p = 10ms$ sine pulse
I_H Maximum holding current	150	mA	$T_J = 25^\circ\text{C}$, anode supply 12V resistive load
I_L Typical latching current	400		

Switching

Parameter	80RIA	Units	Conditions
di/dt Max. non-repetitive rate of rise of turned-on current	300	A/ μ s	$T_J = 125^\circ\text{C}$, $V_d = \text{rated } V_{\text{DRM}}$, $I_{\text{TM}} = 2 \times \text{di/dt snubber } 0.2\mu\text{F}, 15\Omega$, Gate pulse: 20V, 65 Ω , $t_p = 6\mu\text{s}$, $t_r = 0.5\mu\text{s}$ Per JEDEC Standard RS-397, 5.2.2.6.
t_d Typical delay time	1	μs	Gate pulse: 10V, 15 Ω source, $t_p = 6\mu\text{s}$, $t_r = 0.1\mu\text{s}$, $V_d = \text{rated } V_{\text{DRM}}$, $I_{\text{TM}} = 50\text{A}$, $T_J = 25^\circ\text{C}$.
t_q Typical turn-off time	110		$I_{\text{TM}} = 50\text{A}$, $T_J = T_J \text{ max}$, $\text{di/dt} = -5\text{A}/\mu\text{s min.}$, $V_R = 50\text{V}$, $\text{dv/dt} = 20\text{V}/\mu\text{s}$, Gate bias: 0V 25 Ω , $t_p = 500\mu\text{s}$

Blocking

Parameter	80RIA	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	500	V/ μ s	$T_J = 125^\circ\text{C}$ exponential to 67% rated V_{DRM}
I_{RRM} I_{DRM} Max. peak reverse and off-state leakage current	15	mA	$T_J = 125^\circ\text{C}$ rated $V_{\text{DRM}}/V_{\text{RRM}}$ applied

Triggering

Parameter	80RIA	Units	Conditions
P_{GM} Maximum peak gate power	12	W	$T_J = T_J \text{ max}$, $t_p \leq 5\text{ms}$
$P_{\text{G(AV)}}$ Maximum average gate power	3		$T_J = T_J \text{ max}$, $f = 50\text{Hz}$, $d\% = 50$
I_{GM} Max. peak positive gate current	3	A	$T_J = T_J \text{ max}$, $t_p \leq 5\text{ms}$
$+V_{\text{GM}}$ Maximum peak positive gate voltage	20	V	$T_J = T_J \text{ max}$, $t_p \leq 5\text{ms}$
$-V_{\text{GM}}$ Maximum peak negative gate voltage	10		
I_{GT} Max. DC gate current required to trigger	270 120 60	mA	$T_J = -40^\circ\text{C}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$
V_{GT} Max. DC gate voltage required to trigger	3.5 2.5 1.5	V	$T_J = -40^\circ\text{C}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$
I_{GD} DC gate current not to trigger	6	mA	$T_J = T_J \text{ max}$
V_{GD} DC gate voltage not to trigger	0.25		

Max. required gate trigger/ current/ voltage are the lowest value which will trigger all units 6V anode-to-cathode applied

Max. gate current/ voltage not to trigger is the max. value which will not trigger any unit with rated V_{DRM} anode-to-cathode applied

80RIA Series

Thermal and Mechanical Specification

Parameter	80RIA	Units	Conditions
T_J Max. operating temperature range	-40 to 125	°C	
T_{stg} Max. storage temperature range	-40 to 150		
R_{thJC} Max. thermal resistance, junction to case	0.30	K/W	DC operation
R_{thCS} Max. thermal resistance, case to heatsink	0.1		Mounting surface, smooth, flat and greased
T Mounting torque, $\pm 10\%$	15.5 (137)	Nm (lbf-in)	Non lubricated threads
	14 (120)		Lubricated threads
wt Approximate weight	130	g	
Case style	TO-209AC(TO-94)		See Outline Table

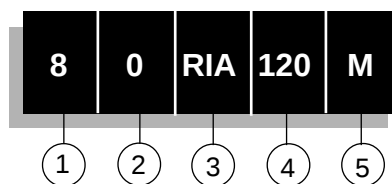
ΔR_{thJ-C} Conduction

(The following table shows the increment of thermal resistance R_{thJ-C} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.042	0.030	K/W	$T_J = T_J \text{ max.}$
120°	0.050	0.052		
90°	0.064	0.070		
60°	0.095	0.100		
30°	0.164	0.165		

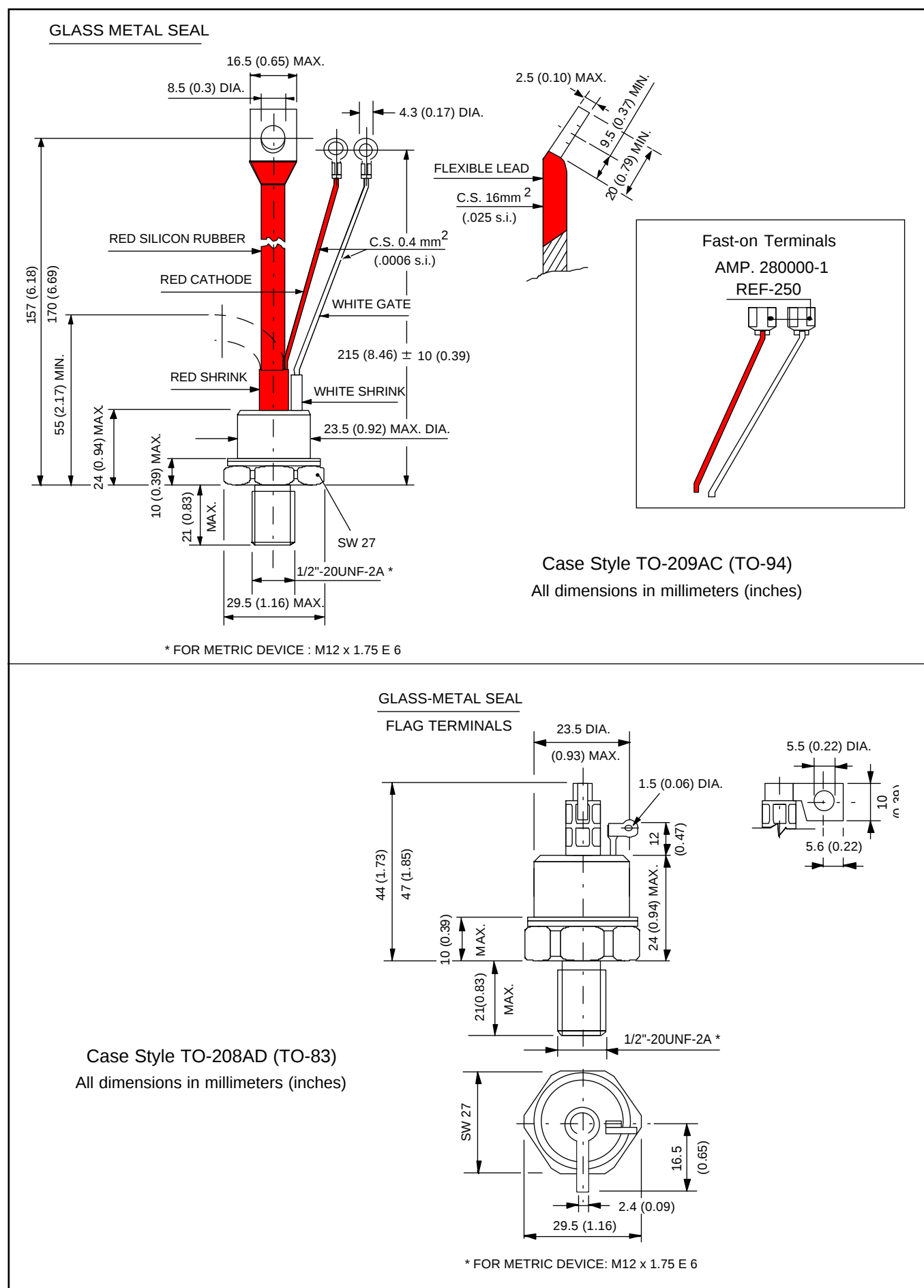
Ordering Information Table

Device Code



- 1** - $I_{TAV} \times 10A$
- 2** - 0 = Eyelet terminals (Gate and Auxiliary Cathode Leads)
1 = Fast - on terminals (Gate and Auxiliary Cathode Leads)
2 = Flag terminals (For Cathode and Gate Terminals)
- 3** - RIA = Essential part number
- 4** - Voltage code: Code $\times 10 = V_{RRM}$ (See Voltage Rating Table)
- 5** - None = Stud base 1/2 "20UNF - 2A threads
M = Stud base metric threads M12 $\times$ 1.75 E 6

Outline Table



80RIA Series

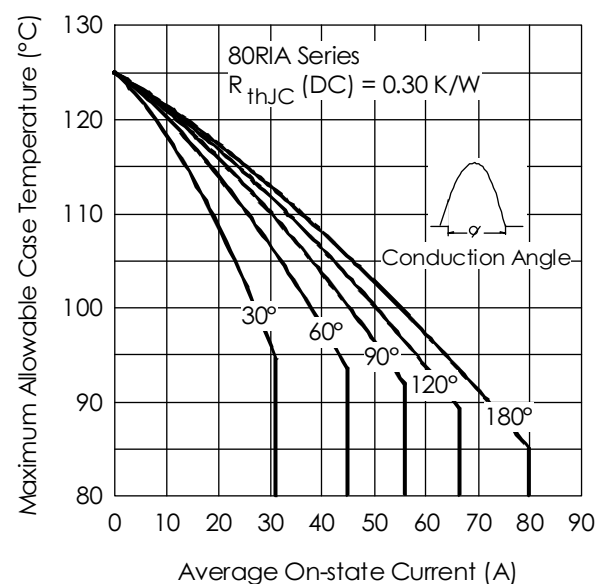


Fig. 1 - Current Ratings Characteristics

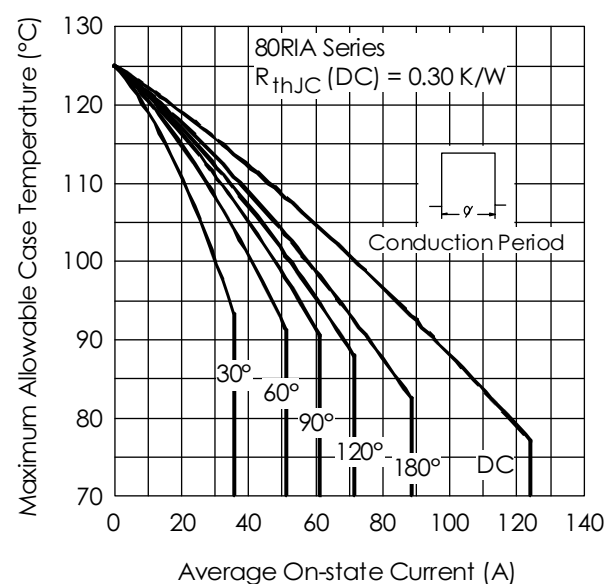


Fig. 2 - Current Ratings Characteristics

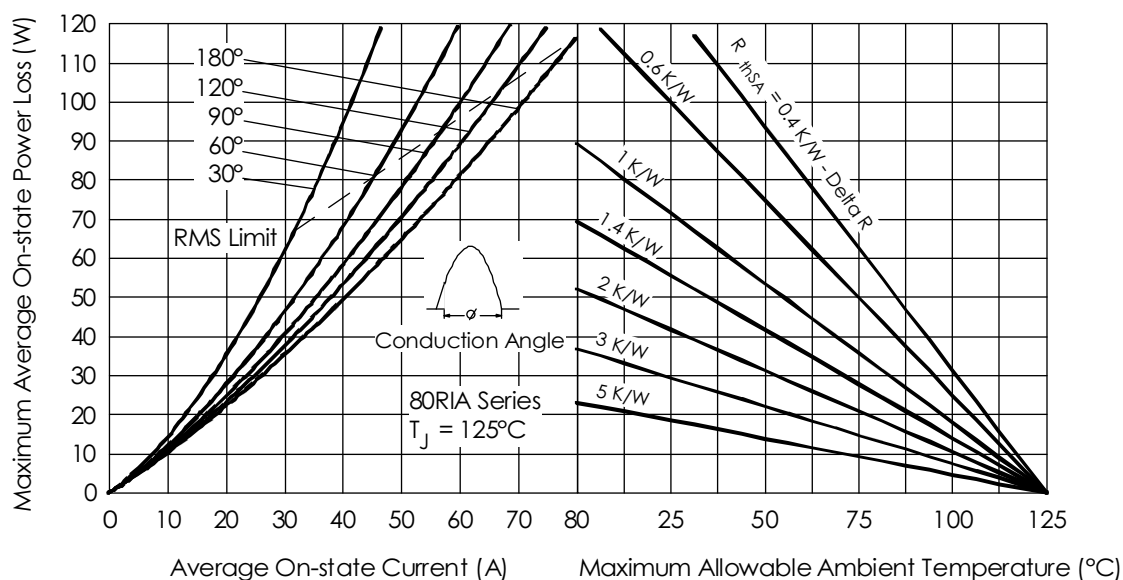


Fig. 3 - On-state Power Loss Characteristics

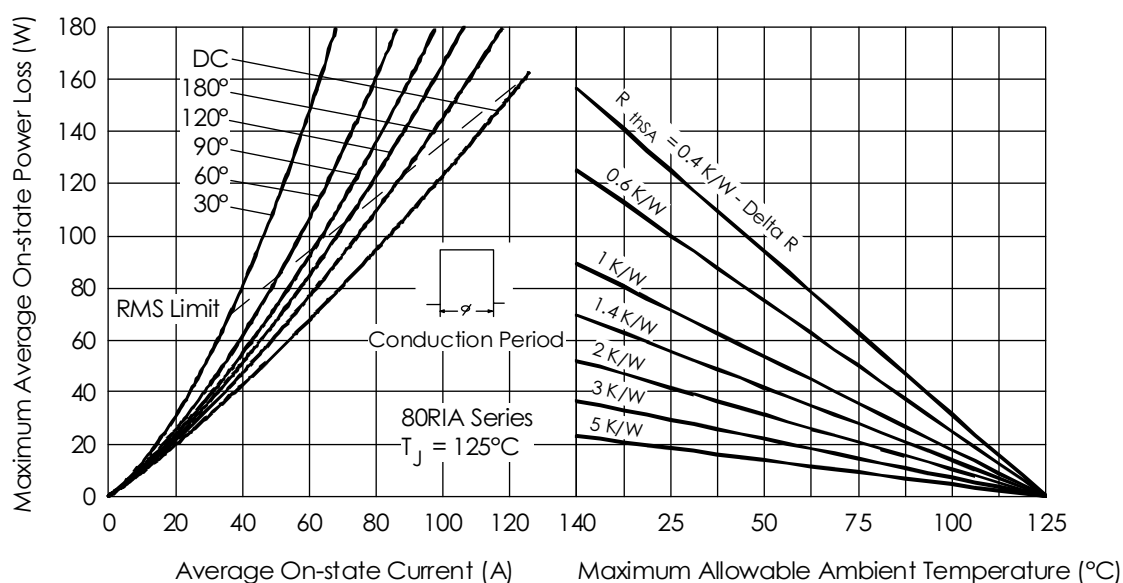


Fig. 4 - On-state Power Loss Characteristics

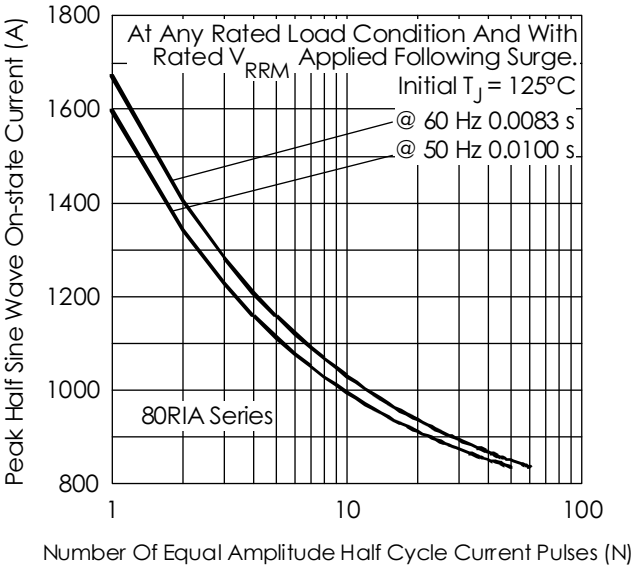


Fig. 5 - Maximum Non-Repetitive Surge Current

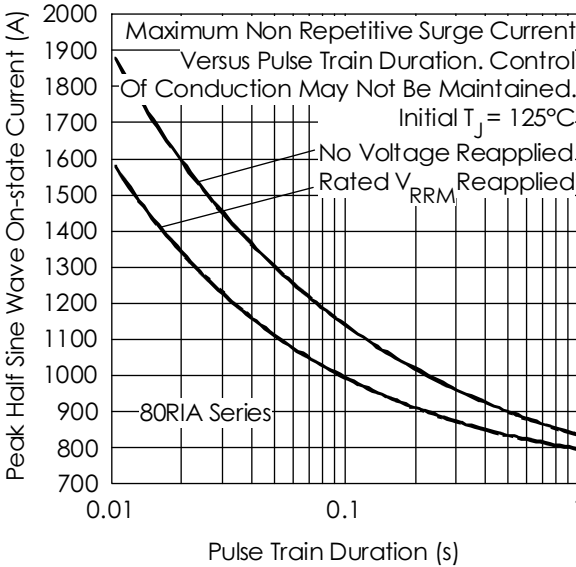


Fig. 6 - Maximum Non-Repetitive Surge Current

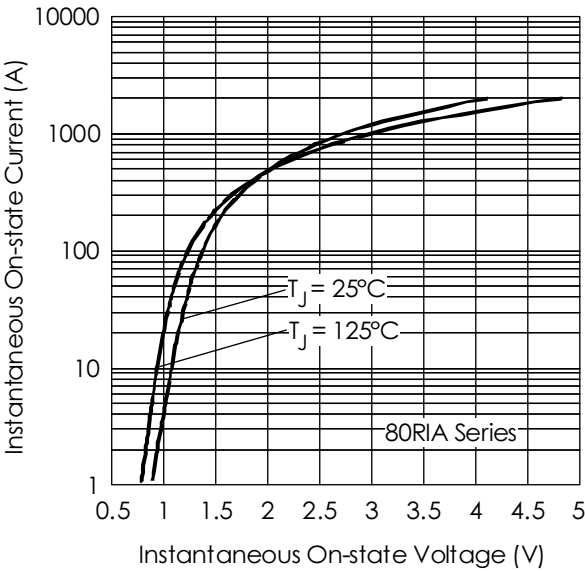


Fig. 7 - On-state Voltage Drop Characteristics

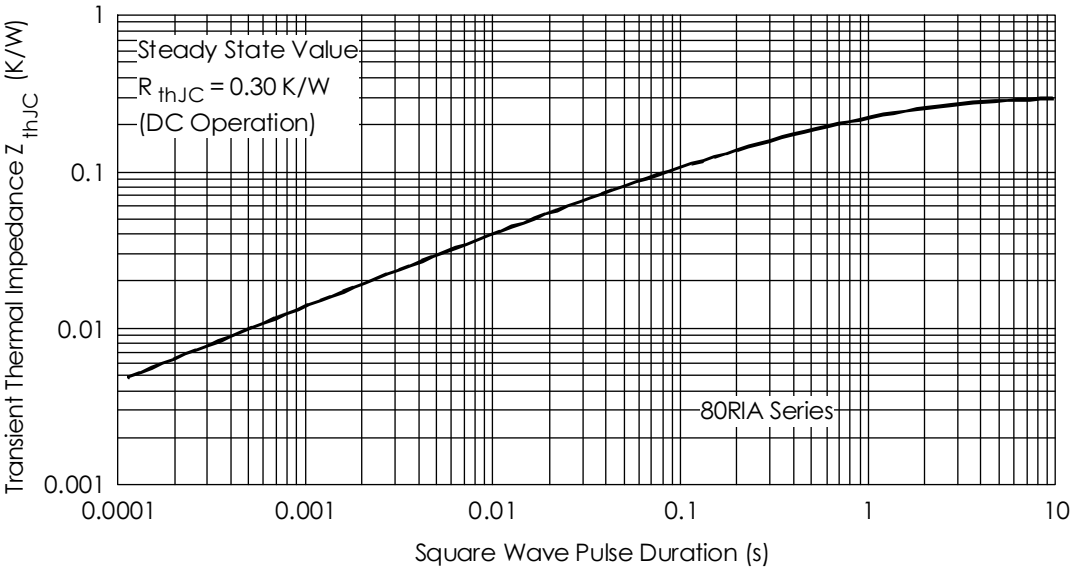


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

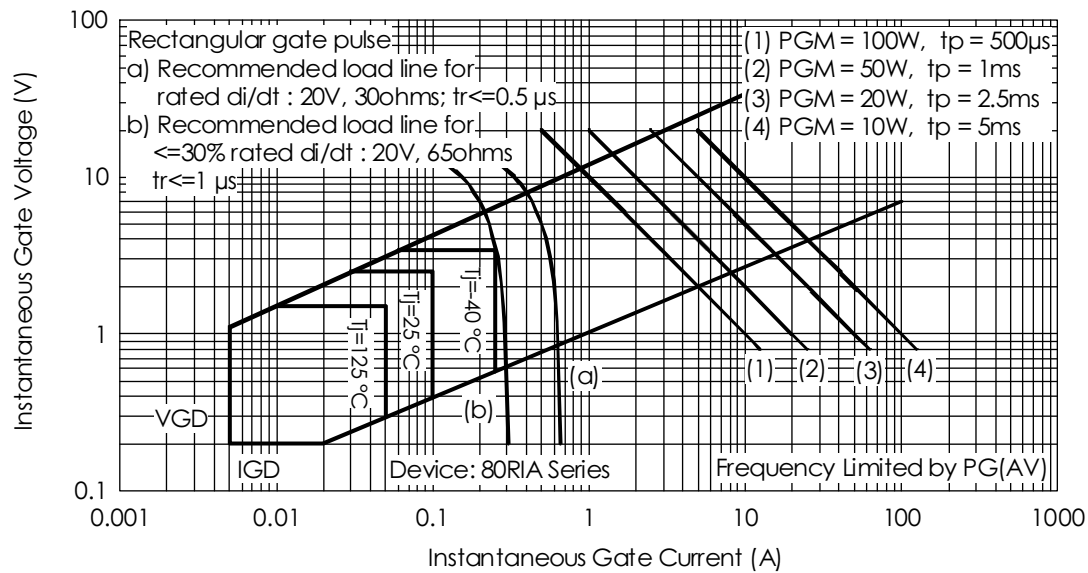


Fig. 9 - Gate Characteristics